



School of Engineering
TEMASEK POLYTECHNIC

THERMAL ANALYSIS OF A SEALED BATTERY POWER SYSTEM ENCLOSURE FOR UNDERWATER OPERATIONS

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COMSOL
CONFERENCE
2015 KUALA LUMPUR

BATTERY POWER SYSTEM

- To power unmanned underwater vehicle
- Completely sealed
- Rugged and safe during operations
- LiFePO₄ battery cells
- Maximum Operating temperature of 50°C



BATTERY THERMAL THEORY



HIGH TEMPERATURE

- Faster chemical reactions
- More power to be extracted
- Improves electron and ion mobility
- Reduces cell's internal impedance
- Increasing cell's capacity

HIGHER TEMPERATURE

- At upper end of scale
- Irreversible chemical reactions
- Loss of electrolytes
- Permanent damage
- Complete failure



THERMAL RISKS

BATTERY OPERATING AT HIGH TEMPERATURES

- Swelling of cell due to expanding chemicals
- Chemical reactions speed up
- Pressure build up in cell well due to gas production
- Cell may rupture and explode

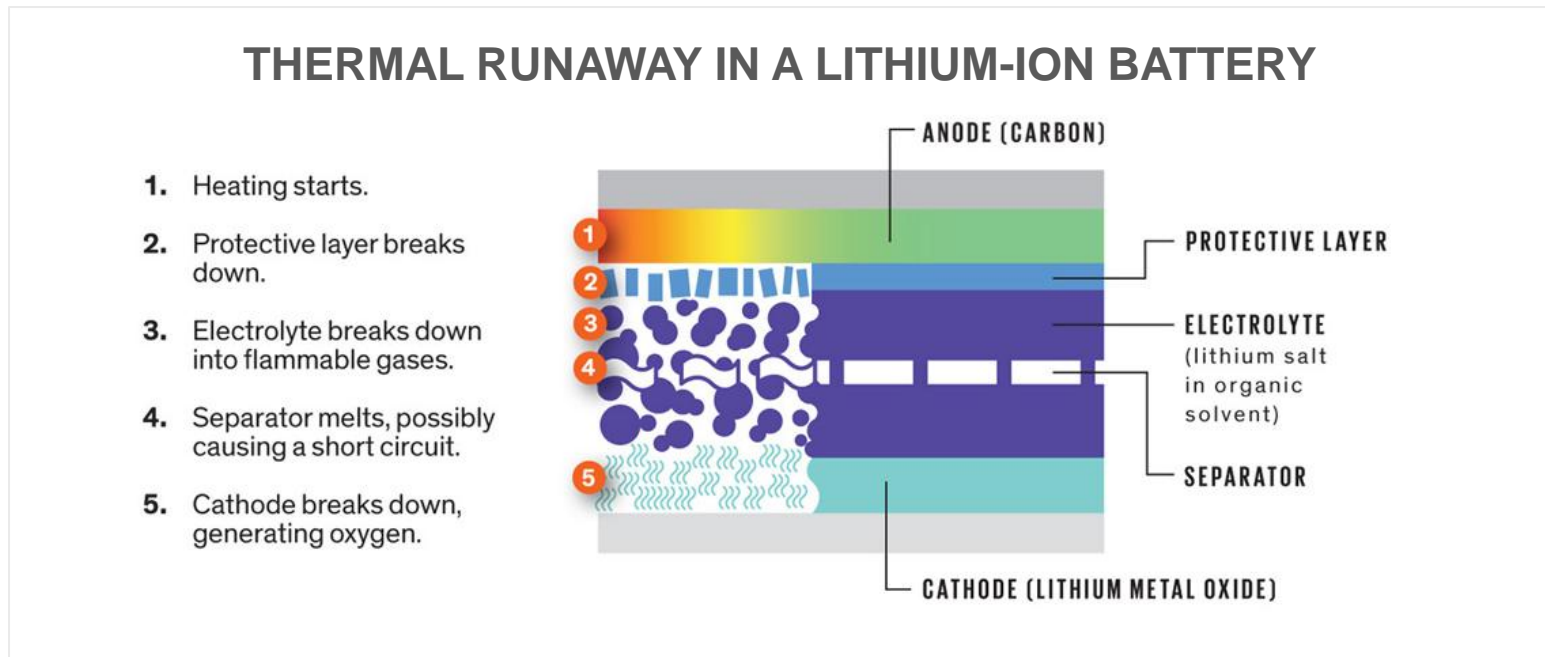


Burnt Batteries: <http://www.komonews.com/news/boeing/Japan-787-probe-finds-thermal-runaway-in-battery-189836111.html>



THERMAL RUNAWAY

- Destruction of battery by thermal energy
- Occurs when rate of heat generation has exceeded the battery's limitation
- Continuous degenerative cycle



Thermal Runaway : <http://www.extremetech.com/extreme/208888-doping-lithium-ion-batteries-could-prevent-overheating-and-explosion>



JOULE HEATING EFFECT

BATTERIES GIVE OFF HEAT VIA

- Thermochemical heating
 - Joule heating

RESISTIVE LOSS OR OHMIC HEATING

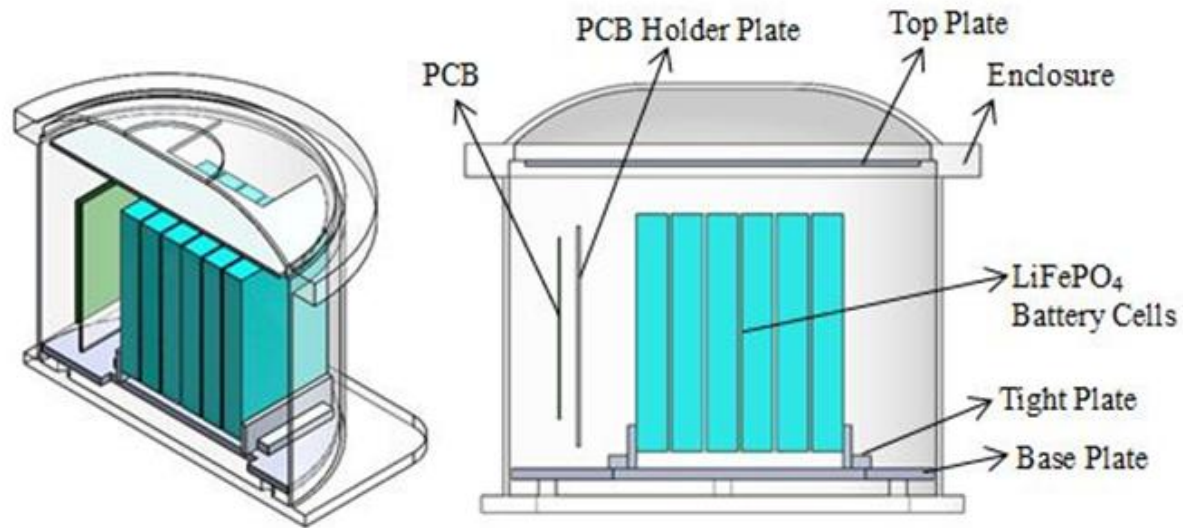
OCCURS WHEN CURRENT FLOWS THROUGH
A RESISTIVE ELEMENT

$$Q_{Joule} = I^2 Ri$$

Where, I is the current (A) and Ri is the internal resistance of the battery (Ω).



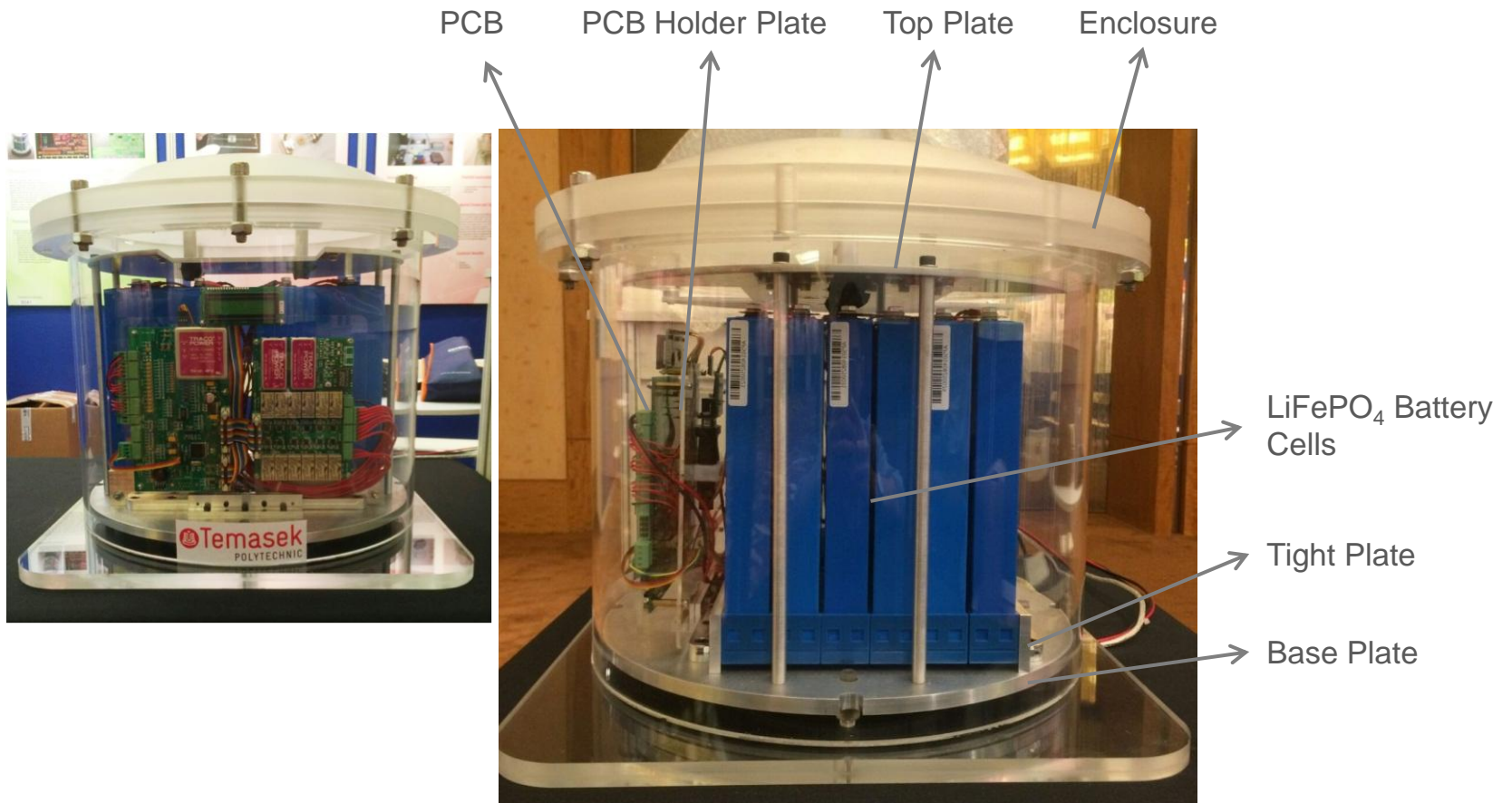
CAD MODEL



- Designed in **SOLIDWORKS**
- Imported to **COMSOL Multiphysics**
- Symmetrical geometry – Symmetry function in COMSOL
- Reduces memory usage and computation time



PROTOTYPE



HEAT TRANSFER

TIME DEPENDENT HEAT TRANSFER EQUATION

$$\rho C_P \frac{\partial T}{\partial t} + \rho C_P \mathbf{u} \cdot \nabla T = \nabla \cdot (k \nabla T) + Q$$

Where, ρ is the density (kg/m^3), C_P is the heat capacity at constant pressure (J/kgK), T is the temperature (K), \mathbf{u} is the velocity field (m/s), k is the thermal conductivity (W/mK) and Q is the heat source (W/m^3).



FLUID FLOW

NAVIER-STOKES EQUATION FOR A COMPRESSIBLE NEWTONIAN FLUID

$$\rho \left(\frac{\partial \mathbf{u}}{\partial t} + \mathbf{u} \cdot \nabla \mathbf{u} \right) = -\nabla p + \nabla \cdot \left(\mu (\nabla \mathbf{u} + (\nabla \mathbf{u})^T) - \frac{2}{3} \mu (\nabla \cdot \mathbf{u}) \mathbf{I} \right) + \mathbf{F}$$

Where, \mathbf{u} is the fluid velocity field (m/s), p is the fluid pressure (Pa), ρ is the fluid density (kg/m³), μ is the fluid dynamic viscosity (Pa.s) and \mathbf{F} is the volume force field (N/m³).

Each term of the equation represents the inertia forces, pressure forces, viscous forces and the external forces applied to the fluid.



FLUID FLOW

THE NAVIER-STOKES EQUATION REPRESENTS THE
CONSERVATION OF MOMENTUM.
THE CONTINUITY EQUATION REPRESENTS THE CONSERVATION OF
MASS.

$$\frac{\partial \rho}{\partial t} + \nabla \cdot (\rho \mathbf{u}) = 0$$

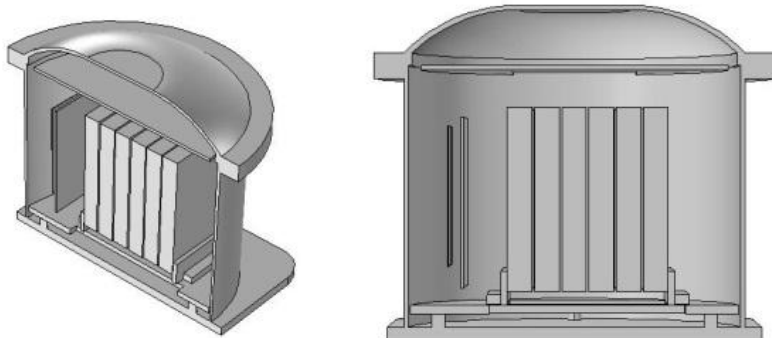
Where, \mathbf{u} is the fluid velocity field (m/s) and ρ is the fluid density (kg/m³).



THERMAL SIMULATION

CAD model in COMSOL

MATERIALS USED



Material	Phase	Thermal Conductivity, k [W/mK]	Heat Capacity, C_p [J/kgK]	Density, [kg/m ³]
Acrylic	Solid	0.18	1470	1190
Air	Liquid	Defined by piecewise functions, dependent on temperature		
Aluminum	Solid	238	900	2700
FR4 (Circuit Board)	Solid	0.3	1369	1900
LiFePO ₄ (Battery)	Solid	1.58	1217	1950



THERMAL SIMULATION

BOUNDARY CONDITIONS

- Physics – Conjugate heat transfer
- Time dependent
- Simulation time of 10800 seconds, 60 seconds step size
- Initial temperature – 295 K
- Initial Pressure – 1 bar
- Heat source – 9.375 W
- Simulated effects of gravity – natural convection



THERMAL SIMULATION

ASSUMPTIONS

- Non-essential structural components removed
- Battery cell treated as a homogenous model
- Electrochemical heat generation not considered
- Heat generation from wiring and circuit board is ignored



EXPERIMENT

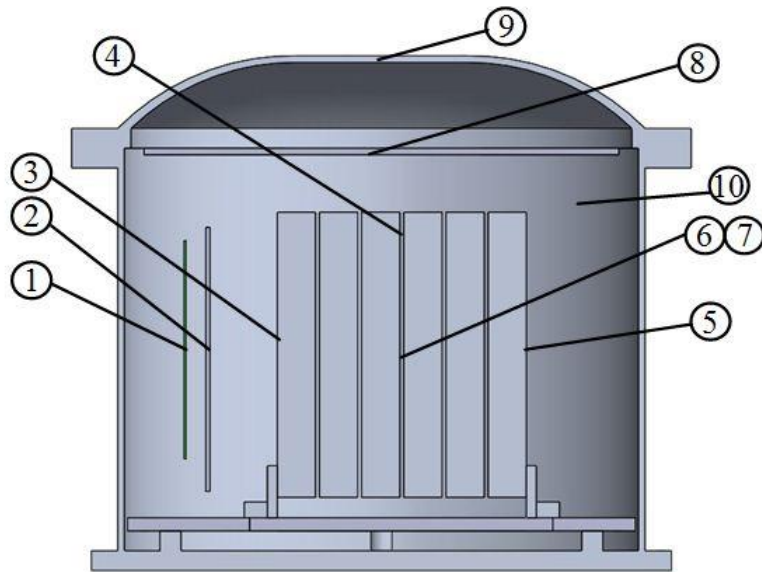


RESULTS USED TO VALIDATE ACCURACY OF SIMULATION



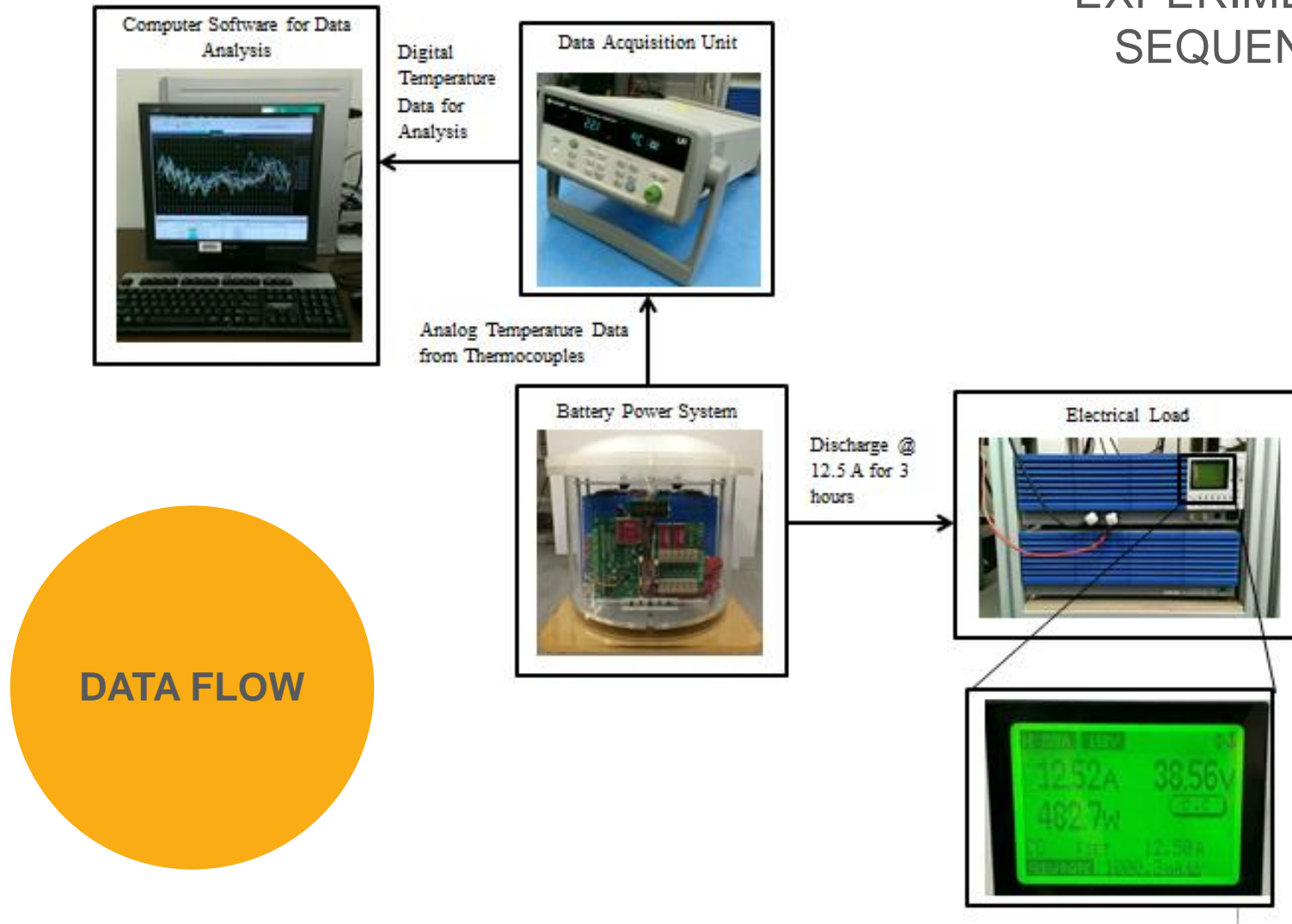
EXPERIMENT

LOCATION OF THERMOCOUPLES



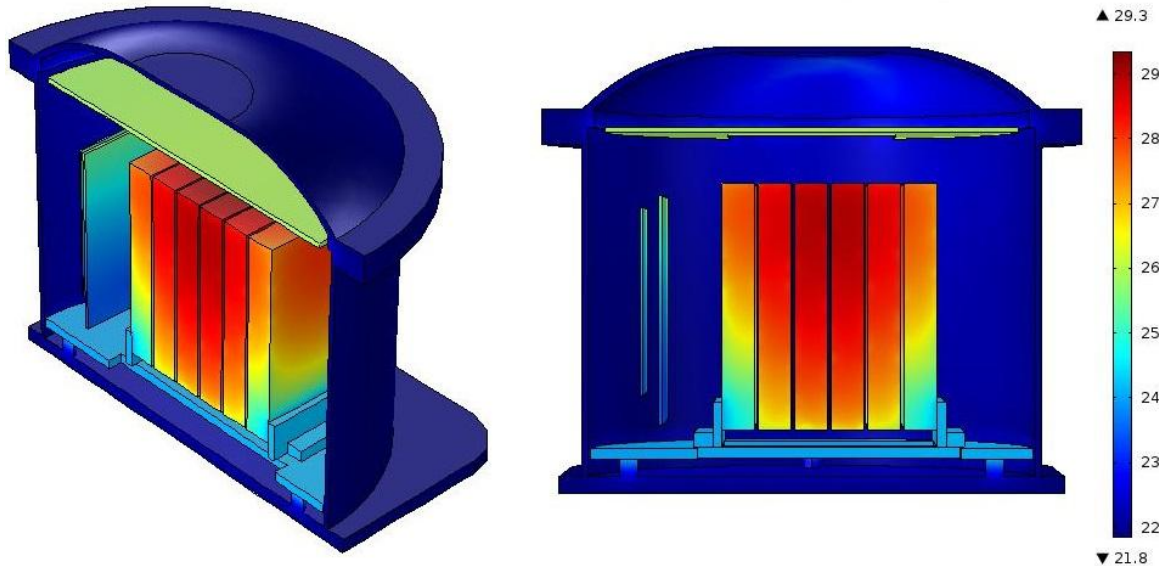
Thermocouple Measuring Points	
N.O.	Location
1	PCB
2	PCB Holder Plate
3	Battery Cell 1
4	Top of Battery Stack
5	Battery Cell 6
6	Between the Battery Stacks
7	Between Battery Stack and Enclosure
8	Top Plate
9	Cover
10	Air Temperature Inside the Enclosure

EXPERIMENT SEQUENCE



THERMAL SIMULATION RESULTS

TO DETERMINE THE MAXIMUM TEMPERATURE AND DEFINE ITS LOCATION

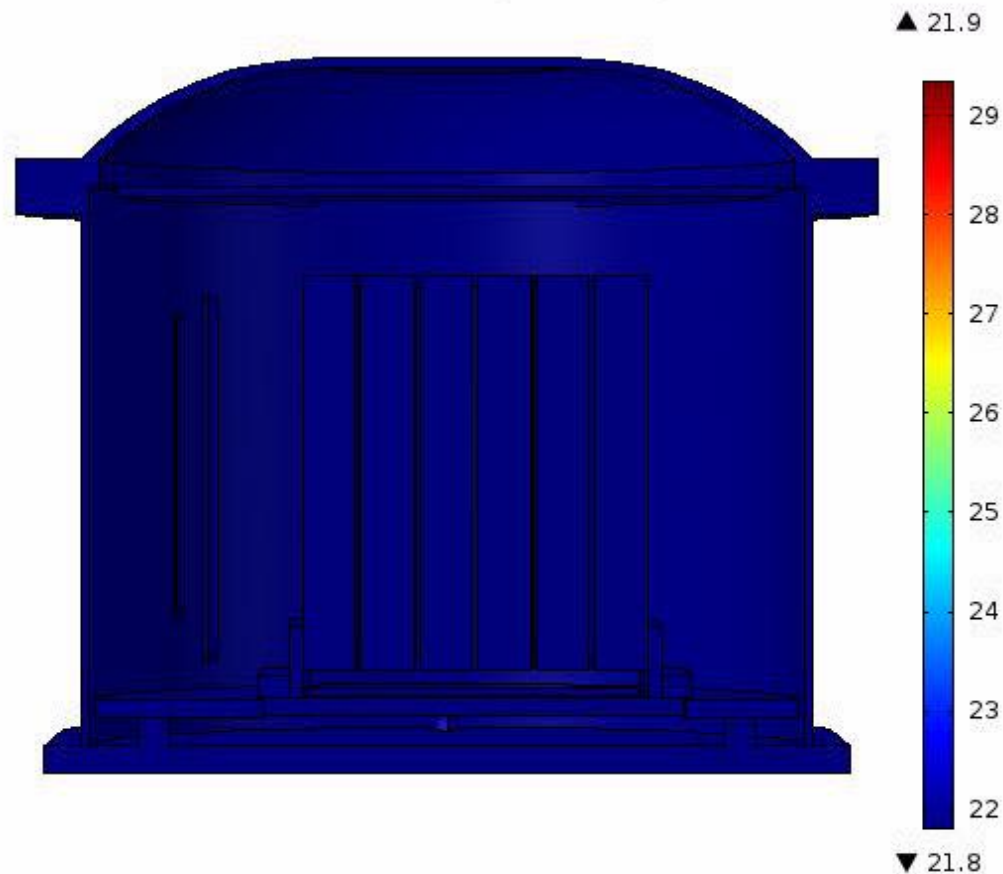


Maximum Temperature = 29.3°C



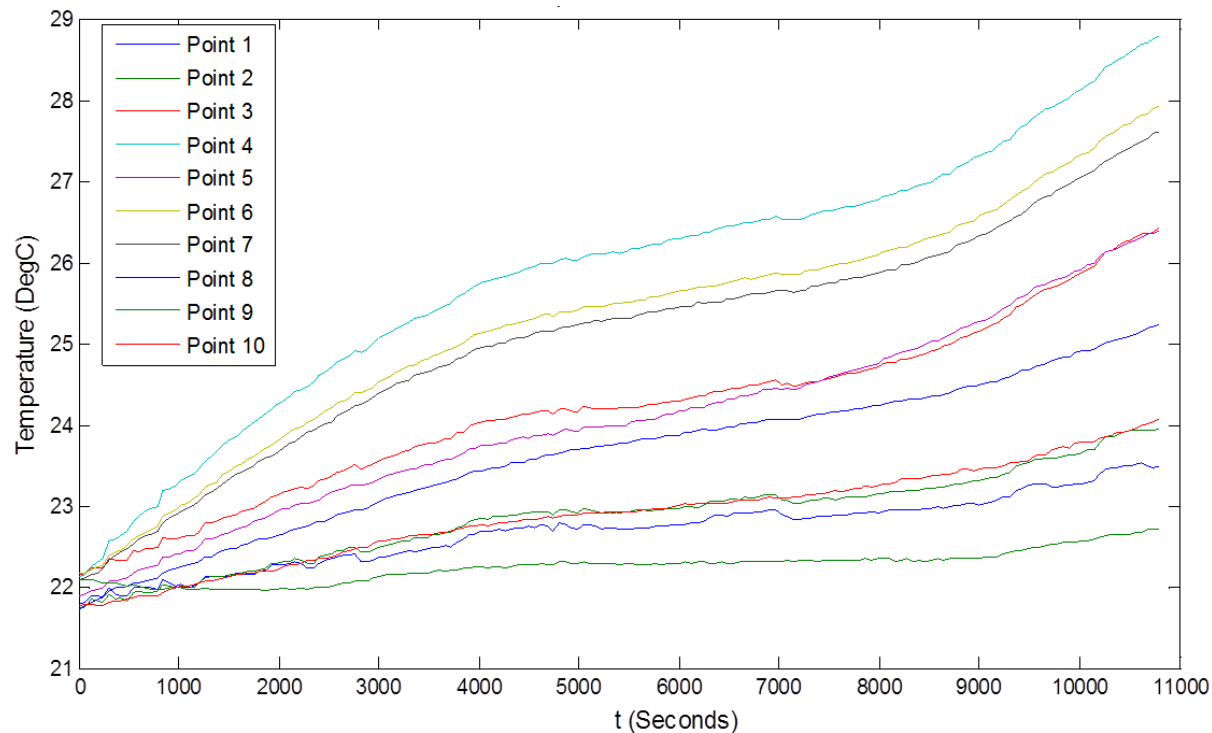
THERMAL SIMULATION RESULTS

Time=0 s Volume: Temperature (degC)



EXPERIMENT RESULTS

TO VERIFY AND DETERMINE THE ACCURACY OF
THE THERMAL SIMULATION



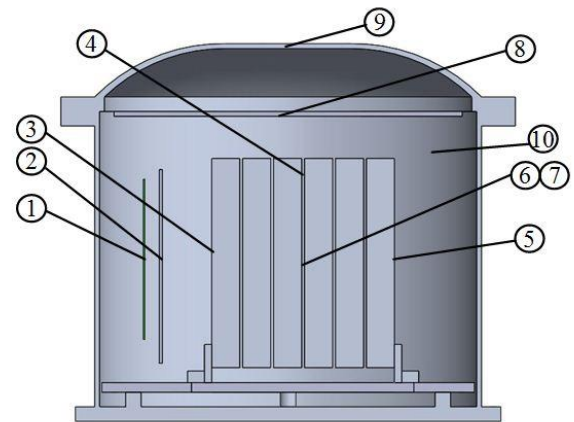
Maximum Temperature = 28.8°C



COMPARISON OF RESULTS

MAXIMUM DATA EXTRACTED FOR EACH DATA POINT

Data Points	Simulation (°C)	Experiment (°C)	Error (°C)	Error (%)	Mean Error (%)	2.21
1	24.2	23.5	0.7	3.0	Standard Error of the Mean (%)	0.35
2	24.2	23.9	0.3	1.3	Root Mean Squared Error (%)	2.45
3	27.1	26.4	0.7	2.7		
4	29.3	28.8	0.5	1.7		
5	27.1	26.4	0.7	2.7		
6	28.0	27.9	0.1	0.4		
7	28.3	27.6	0.7	2.5		
8	25.9	25.2	0.7	2.8		
9	22.5	22.7	0.2	0.9		
10	25.1	24.1	1.0	4.1		

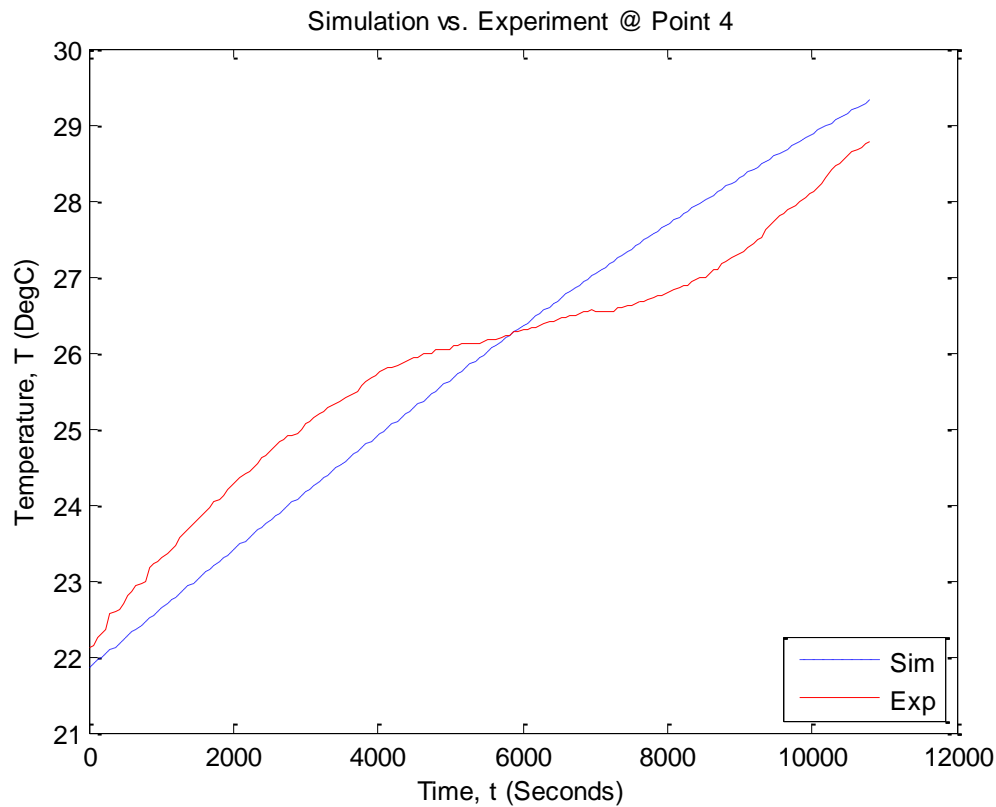


Marginal and acceptable error

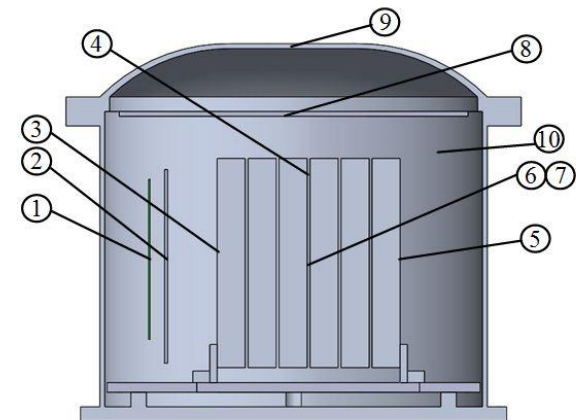


COMPARISON OF *RESULTS*

MAXIMUM TEMPERATURE – POINT 4



Method	Temperature
Simulation (°C)	29.3
Experiment (°C)	28.8
Error (°C)	0.5



SUMMARY

- Maximum temperature during discharge cycle is lower than the safe working temperature of 50°C
- Battery power system capable of operating continuously for 3 hours without exceeding the temperature limit
- Validation of simulation results
- Capability of using the COMSOL simulation model for subsequent thermal simulations



FUTURE WORKS

- Implementation of thermal management via phase change material (PCM)
- Addition of temperature feedback control system





THANK YOU!

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